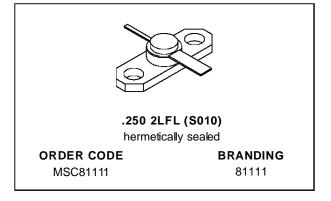
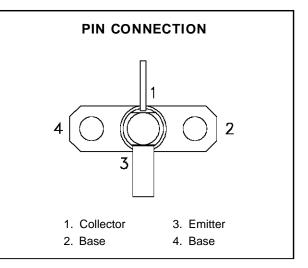


RF & MICROWAVE TRANSISTORS GENERAL PURPOSE AMPLIFIER APPLICATIONS

- EMITTER BALLASTED
- REFRACTORY/GOLD METALLIZATION
- VSWR CAPABILITY ∞:1 @ RATED CONDITIONS
- HERMETIC STRIPAC[®] PACKAGE
- $P_{OUT} = 5.0$ W MIN. WITH 10 dB GAIN @ 1 GHz





DESCRIPTION

The MSC81111 is a common base hermetically sealed silicon NPN microwave transistor utilizing a fishbone emitter ballasted geometry with a re-fractory/gold metallization system. This device is capable of withstanding an infinite load VSWR at any phase angle under rated rated conditions. The MSC81111 is designed for Class C amplifier applications in the 0.4 - 1.2 GHz frequency range.

ABSOLUTE	MAXIMUM	RATINGS	$(T_{case} = 25^{\circ}C)$)
----------	---------	---------	----------------------------	---

Symbol	Parameter	Value	Unit
PDISS	Power Dissipation* $(T_C \le 50^{\circ}C)$	18.75	W
Ι _C	Device Current*	600	mA
V _{CC}	Collector-Supply Voltage*	35	V
TJ	Junction Temperature	200	°C
T _{STG}	Storage Temperature	– 65 to +200	°C

THERMAL DATA

RTH(j-c)	Junction-Case Thermal Resistance*	8.0	°C/W
Applies only to rated R	RTH(j-c) JUNCTION-Case Thermal Resistance Applies only to rated RF amplifier operation		

ELECTRICAL SPECIFICATIONS $(T_{case} = 25^{\circ}C)$

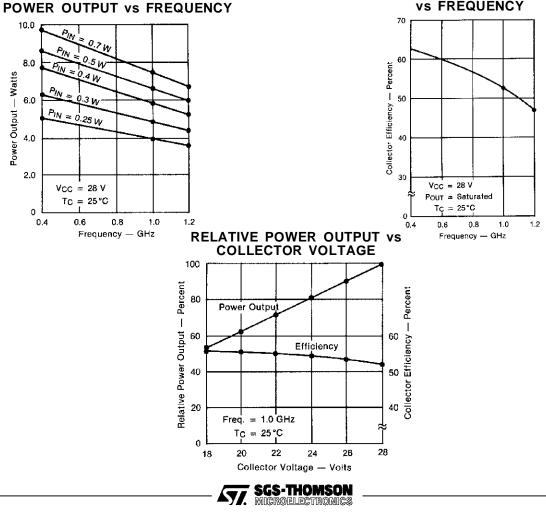
STATIC

Symbol	Test Conditions	Value			Unit		
	Test conditions		Min.	Тур.	Max.	Unit	
ВVсво	$I_C = 1 m A$	$I_E = 0 m A$		45			V
BV _{EBO}	$I_E = 1 m A$	$I_C = 0mA$		3.5	—		V
BV _{CER}	IC = 5mA	$R_{BE} = 10\Omega$		45	—		V
I _{СВО}	$V_{CB} = 28V$			—	—	1.0	mA
hFE	$V_{CE} = 5V$	$I_C = 200 \text{mA}$		15	—	120	_

DYNAMIC

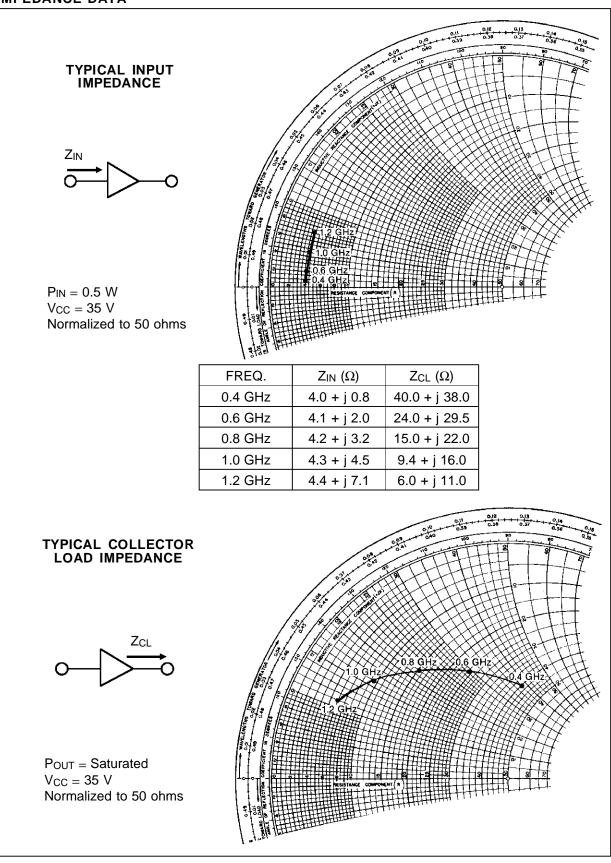
Symbol	mbol Test Conditions			Value			
Symbol			Min.	Тур.	Max.	Unit	
Роит	f = 1.0 GHz	$P_{IN}=0.5\ W$	$V_{CC} = 28 V$	5.0	6.6		W
ηc	f = 1.0 GHz	$P_{\text{IN}}=0.5~\text{W}$	$V_{CC} = 28 V$	50	52	_	%
GP	f = 1.0 GHz	$P_{IN}=0.5\ W$	$V_{CC} = 28 V$	10	11.2	—	dB
C _{OB}	f = 1 MHz	$V_{CB} = 28 V$		—	—	6.5	pF

TYPICAL PERFORMANCE

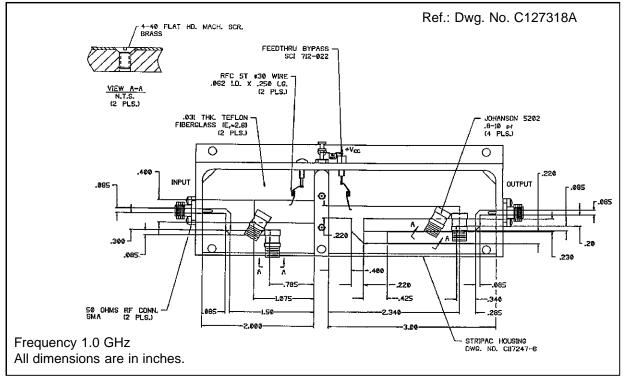


COLLECTOR EFFICIENCY vs FREQUENCY

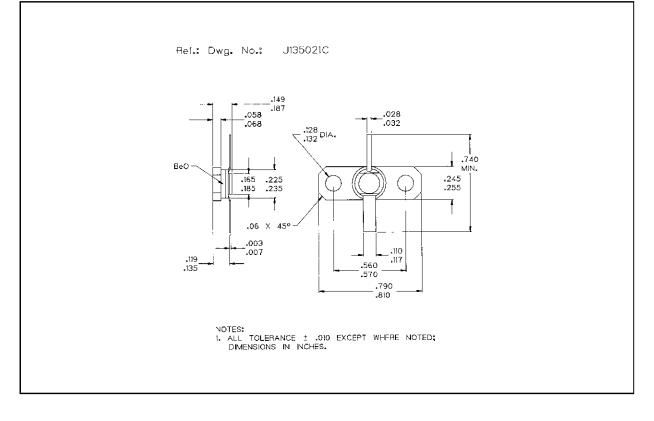




TEST CIRCUIT



PACKAGE MECHANICAL DATA





Information furnished is believed to be accurate and reliable. However, SGS-THOMSON Microelectronics assumes no responsability for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may results from its use. No license is granted by implication or otherwise under any patent or patent rights of SGS-THOMSON Microelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. SGS-THOMSON Microelectronics products are not authorized for use ascritical components in life support devices or systems without express written approval of SGS-THOMSON Microelectonics.

© 1994 SGS-THOMSON Microelectronics - All Rights Reserved

SGS-THOMSON Microelectronics GROUP OF COMPANIES

Australia - Brazil - France - Germany - Hong Kong - Italy - Japan - Korea - Malaysia - Malta - Morocco - The Netherlands -Singapore - Spain - Sweden - Switzerland - Taiwan - Thailand - United Kingdom - U.S.A

